

Technical Data Sheet

0. 6mm Height Flat Top LED

19-215SYGC/S530-XX/TR8

Features

- Package in 8mm tape on 7" diameter reel.
- Compatible with automatic placement equipment.
- Compatible with infrared and vapor phase reflow solder process.
- Mono-color type.

Descriptions

- The 19-215 SMD Taping is much smaller than lead frame type components, thus enable smaller board size, higher packing density, reduced storage space and finally smaller equipment to be obtained.
- Besides, lightweight makes them ideal for miniature applications. etc.

Applications

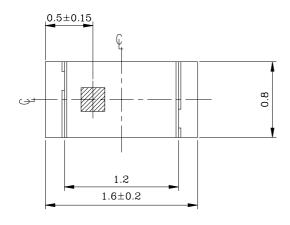
- Automotive: backlighting in dashboard and switch.
- Telecommunication: indicator and backlighting in telephone and fax.
- Flat backlight for LCD, switch and symbol.
- General use.

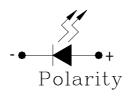
Device Selection Guide

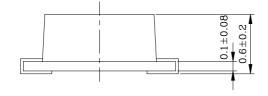
	Lang Colon		
Material	Emitted Color	Lens Color	
AlGaInP	Super Yellow Green	Water Clear	



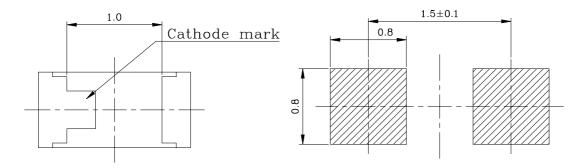
Package Outline Dimensions







For reflow soldering (propose)



Notes: Tolerances Unless Dimension \pm 0.1mm, Unit = mm

Prepared date: 07-22-2003



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19-215SYGC/S530-XX/TR8

Absolute Maximum Ratings (Ta=25℃)

Parameter	Symbol	Rating	Unit	
Reverse Voltage	V_R	5	V	
Forward Current	I F	25	mA	
Operating Temperature	Topr	-40 ~ +85	$^{\circ}\!\mathbb{C}$	
Storage Temperature	Tstg	-40~ +90	$^{\circ}\! \mathbb{C}$	
Soldering Temperature	Tsol	260	$^{\circ}\! C$	
C I		(for 5 second)		
Electrostatic Discharge	ESD	2000	V	
Power Dissipation	Pd	60	mW	
Peak Forward Current (Duty 1/10 @1KHz)	IF (PEAK)	60	mA	

Electro-Optical Characteristics (Ta=25°C)

Parameter	Symbol	*Chip Rank	Min.	Тур.	Max.	Unit	Condition
Luminous Intensity	Iv	E1	10	16		mcd	
		E2	16	21			I _F =20mA
		E3	21	28			
		E4	28	33			
Viewing Angle	2 \theta 1/2			120		deg	I _F =20mA
Peak Wavelength	λр			575		nm	I _F =20mA
Dominant Wavelength	λd			573		nm	I _F =20mA
Spectrum Radiation Bandwidth	Δλ			20		nm	I _F =20mA
Forward Voltage	VF			2.0	2.4	V	I _F =20mA
Reverse Current	Ir				10	μ A	V _R =5V

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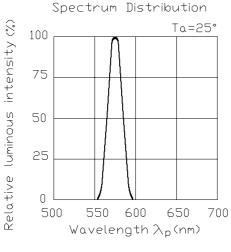
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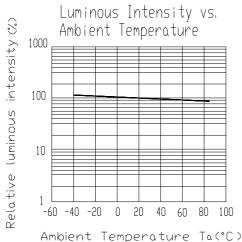
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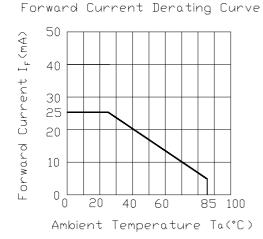
Device No:DSE-195-103

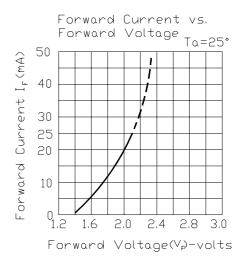
Prepared date: 07-22-2003

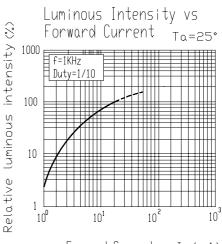
Typical Electro-Optical Characteristics Curves

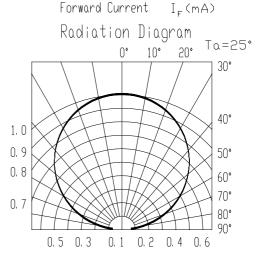












Label explanation

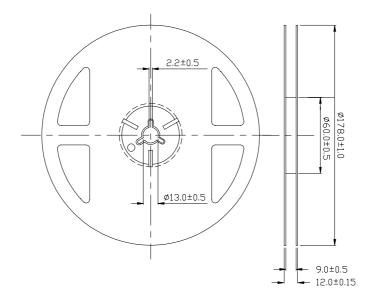
CAT: Luminous Intensity Rank

HUE: Dom. Wavelength Rank

REF: Forward Voltage Rank

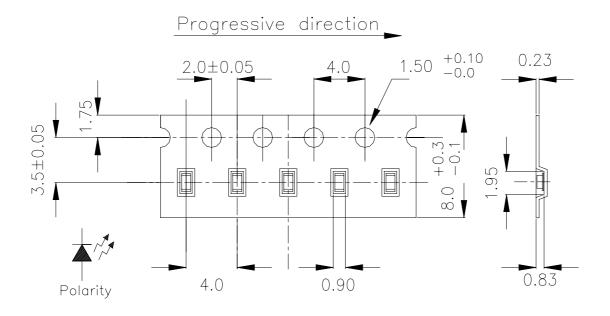


Reel Dimensions



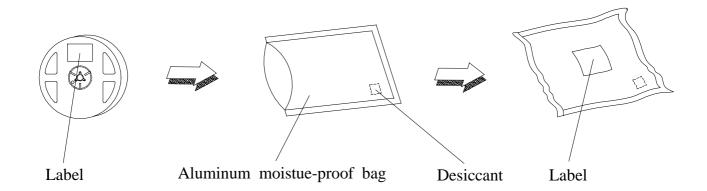
Note: Tolerances Unless Dimension \pm 0.1mm, Unit = mm

Carrier Tape Dimensions: Loaded quantity 3000 PCS per reel



Note: Tolerances Unless Dimension \pm 0.1mm, Unit = mm

Moisture Resistant Packaging



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Reliability Test Items And Conditions

The reliability of products shall be satisfied with items listed below.

Confidence level: 90%

LTPD: 10%

No.	Items	Test Condition	Test Hours/Cycles	Sample Size	Ac/Re
1	Reflow Soldering	Temp. : 240°C± 5°C 5 sec.	6 Min.	22 Pcs.	0/1
2	Temperature Cycle	$H: +100^{\circ}\mathbb{C}$ 15min \int 5 min $L: -40^{\circ}\mathbb{C}$ 15min	300 Cycles	22 PCS.	0/1
3	Thermal Shock	H:+100°C 5min ∫ 10 sec L:-10°C 5min	300 Cycles	22 PCS.	0/1
4	High Temperature Storage	Temp. : 100°C	1000 Hrs.	22 PCS.	0/1
5	Low Temperature Storage	Temp. : -55°℃	1000 Hrs.	22 PCS.	0/1
6	DC Operating Life	$I_F = 20 \text{ mA}$	1000 Hrs.	22 PCS.	0/1
7	High Temperature / High Humidity	85°C/RH85%	1000 Hrs.	22 PCS.	0/1

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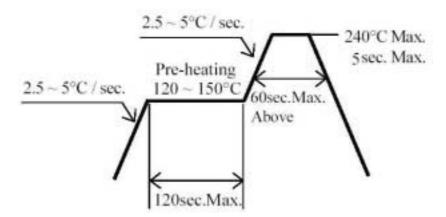
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Precautions For Use

1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

- 2. Storage
 - 2.1 Do not open moisture proof bag before the products are ready to use.
 - 2.2 Before opening the package, the LEDs should be kept at 30°C or less and 90%RH or less.
 - 2.3 The LEDs should be used within a year.
 - 2.4 After opening the package, the LEDs should be kept at 30°C or less and 70%RH or less.
 - 2.5 The LEDs should be used within 168 hours (7 days) after opening the package.
 - 2.6 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions. Baking treatment: $60\pm~5^{\circ}$ C for 24 hours.
- 3. Soldering Condition
- 3.1 Lead solder temperature profile



- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.

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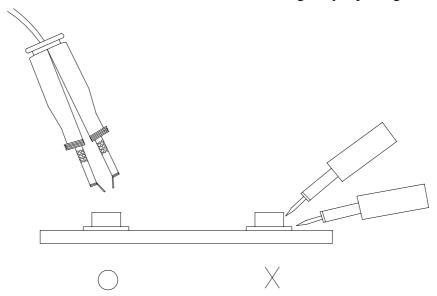


4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 280°C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

5.Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



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